

Customer No.: 31561  
Application No.: 10/709,924  
Docket NO.: 13366-US-PA

REMARKS

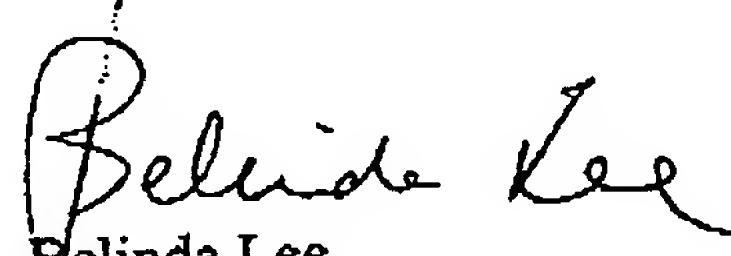
In response to the Office Action, mailed on November 03, 2004, a complete listing of all of the claims is presented herewith. Applicant would like to elect Group I, claims 1-6, drawn to semiconductor device, classified in class 257, subclass 335. Please cancel Group II, claims 7-14, drawn to method of making semiconductor device, classified in class 438, subclass 298, without waiver, prejudice or disclaimer.

If the Examiner believes that a telephone conference would expedite the examination of the above-identified patent application, the Examiner is invited to call the undersigned.

Respectfully submitted,

Date:

May 3, 2005



Belinda Lee

Registration No.: 46,863

Jianq Chyun Intellectual Property Office  
7<sup>th</sup> Floor-1, No. 100  
Roosevelt Road, Section 2  
Taipei, 100  
Taiwan  
Tel: 011-886-2-2369-2800  
Fax: 011-886-2-2369-7233  
Email: [belinda@jcipgroup.com.tw](mailto:belinda@jcipgroup.com.tw)  
[Usa@jcipgroup.com.tw](mailto:Usa@jcipgroup.com.tw)